

UNISONIC TECHNOLOGIES CO., LTD

4NM120

Preliminary

4.0A, 1200V N-CHANNEL SUPER-JUNCTION MOSFET

DESCRIPTION

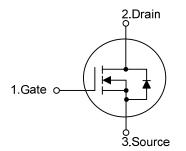
The UTC **4NM120** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at AC-DC converters for power applications.

FEATURES

* $R_{DS(ON)} \le 3.5 \Omega$ @ V_{GS}=10V, I_D=2.0A

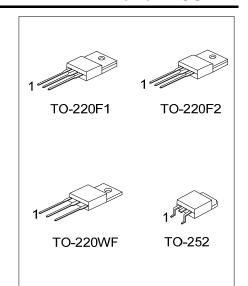
* High Switching Speed

SYMBOL



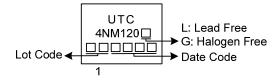
ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Dealing	
Lead Free	Free Halogen Free		1	2	3	Packing	
4NM120L-TF1-T 4NM120G-TF1-T		TO-220F1	G	D	S	Tube	
4NM120L-TF2-T	4NM120G-TF2-T	TO-220F2	G	D	S	Tube	
4NM120L-TW1-T	4NM120G-TW1-T	TO-220WF	G	D	S	Tube	
4NM120L-TN3-R	4NM120G-TN3-R	TO-252	G	D	S	Tape Reel	
Note: Pin Assignment: G: Gate D: Drain S: Source							
4NM120G-TF1-T	(1) T: Tube, R: Tape Reel (2) TF1: TO-220F1, TF2: TO-220F2, TW1: TO-220WF TN3: TO-252 (3) G: Halogen Free and Lead Free, L: Lead Free						



4NM120

MARKING





■ ABSOLUTE MAXIMUM RATINGS (unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V _{DSS}	1200	V	
Gate-Source Voltage		V _{GSS}	±30	V	
Continuous Drain Current	Continuous	ID	4	А	
	Pulsed	I _{DM}	8	А	
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	95	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	2	V/ns	
Power Dissipation	TO-220F1 TO-220F2 TO-220WF	PD	24	w	
	TO-252		28	W	
Junction Temperature		TJ	+150	°C	
Storage Temperature		T _{STG}	-55 ~ +150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. L = 100mH, I_{AS} = 1.37A, V_{DD} = 50V, R_G = 25 Ω Starting T_J = 25°C

4. Is_D \leq 4.0A, di/dt \leq 200A/µs, V_{DD} \leq BV_{DSS}, Starting T_J = 25°C

THERMAL DATA

PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	TO-220F1 TO-220F2 TO-220WF	θ」Α	62.5	°C/W
	TO-252		110	°C/W
Junction to Case	TO-220F1 TO-220F2 TO-220WF	θις	5.2	°C/W
	TO-252		4.46 (Note)	°C/W

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.



■ ELECTRICAL CHARACTERISTICS

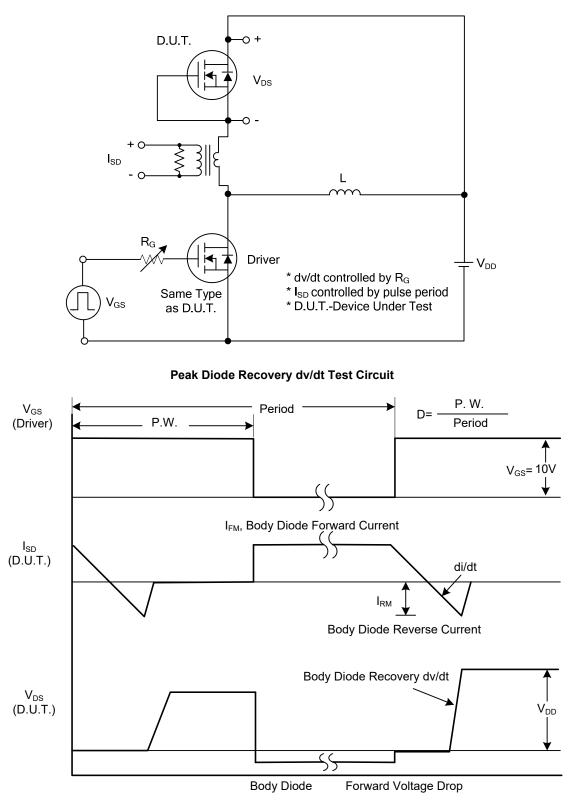
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS		• • • • • • • • • • • • • • • • • • •				
Drain-Source Breakdown Voltage	BV _{DSS}	I _D =250μA, V _{GS} =0V	1200			V
Drain-Source Leakage Current	I _{DSS}	V _{DS} =1200V, V _{GS} =0V			10	μA
Forward		V _{GS} =+30V, V _{DS} =0V			+100	nA
Gate-Source Leakage Current Reverse	I _{GSS}	V _{GS} =-30V, V _{DS} =0V			-100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250µA	2.5		4.5	V
Static Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =2.0A			3.5	Ω
DYNAMIC PARAMETERS						
Input Capacitance	CISS			420		рF
Output Capacitance	Coss	V _{GS} =0V, V _{DS} =50V, f=1.0MHz		28		рF
Reverse Transfer Capacitance	C _{RSS}			2.5		рF
SWITCHING PARAMETERS						
Total Gate Charge	Q _G			24		nC
Gate to Source Charge	Q _{GS}	V _{DS} =960V, V _{GS} =10V, I _D =4.0A (Note 1, 2)		8		nC
Gate to Drain Charge	Q_{GD}			6.8		nC
Turn-ON Delay Time	t _{D(ON)}			7		ns
Rise Time	t _R	V _{DD} =100V, V _{GS} =10V, I _D =4.0A,		17.6		ns
Turn-OFF Delay Time	t _{D(OFF)}	R _G =25Ω (Note 1, 2)		53		ns
Fall-Time	t⊢			35		ns
SOURCE- DRAIN DIODE RATINGS AND C	HARACTER	ISTICS				
Maximum Body-Diode Continuous Current	ls				4	Α
Maximum Body-Diode Pulsed Current	lsм				8	А
Drain-Source Diode Forward Voltage	Vsd	Is=4.0A, V _{GS} =0V			1.4	V
Body Diode Reverse Recovery Time	trr	Is=4.0A, V _{GS} =0V,		490		ns
Reverse Recovery Charge	Qrr	dl⊧/dt=100A/µs (Note 1)		4.8		μC

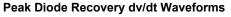
Notes: 1. Pulse Test: Pulse width \leq 1200µs, Duty cycle \leq 2%.

2. Essentially independent of operating temperature.



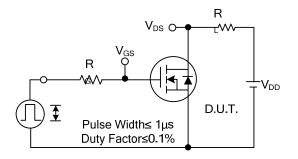
TEST CIRCUITS AND WAVEFORMS



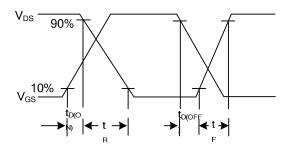




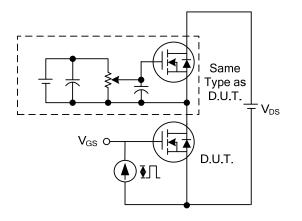
TEST CIRCUITS AND WAVEFORMS



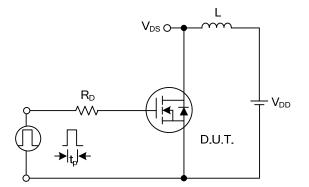
Switching Test Circuit



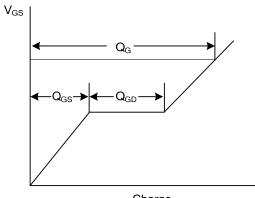
Switching Waveforms



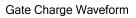
Gate Charge Test Circuit

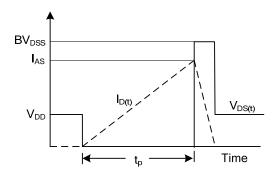


Unclamped Inductive Switching Test Circuit



Charge





Unclamped Inductive Switching Waveforms



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